

# RS1G79-Q1 Single Positive-Edge-Triggered D-Type Flip-Flop

## 1 FEATURES

- **Qualified for Automotive Applications**
- **AEC-Q100 Qualified with the Grade 1**
- **Operating Voltage Range: 1.65V to 5.5V**
- **Low Power Consumption: 10 $\mu$ A (Max)**
- **Operating Temperature Range: -40°C to +125°C**
- **Inputs Accept Voltage to 5.5V**
- **High Output Drive:  $\pm$ 24mA at  $V_{CC}$ =3.0V**
- **I<sub>off</sub> Supports Live Insertion, Partial-Power Down Mode, and Back-Drive Protection**
- **Micro Size Packages: SC70-5**

## 2 APPLICATIONS

- **HEV/EV Battery Management System (BMS)**
- **Automotive Infotainment & Cluster**
- **Automotive HEV/EV Powertrain**

## 3 DESCRIPTIONS

The RS1G79-Q1 single positive-edge-triggered D-type flip-flop is designed for 1.65V to 5.5V  $V_{CC}$  operation.

When data at the data (D) input meets the setup time requirement, the data is transferred to the Q output on the positive-going edge of the clock pulse. Clock triggering occurs at a voltage level and is not directly related to the rise time of the clock pulse. Following the hold-time interval, data at the D input can be changed without affecting the level at the output.

The RS1G79-Q1 is fully specified for partial-power-down applications using I<sub>off</sub>. The I<sub>off</sub> circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

This device available in Green SC70-5 packages. It operates over an ambient temperature range of -40°C to +125°C.

### Device Information <sup>(1)</sup>

| PART NUMBER | PACKAGE | BODY SIZE (NOM)        |
|-------------|---------|------------------------|
| RS1G79-Q1   | SC70-5  | 2.10mm $\times$ 1.25mm |

(1) For all available packages, see the orderable addendum at the end of the data sheet.

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## 4 REVISION HISTORY

Note: Page numbers for previous revisions may differ from page numbers in the current version.

| <b>Version</b> | <b>Change Date</b> | <b>Change Item</b>            |
|----------------|--------------------|-------------------------------|
| A.0            | 2024/04/24         | Preliminary version completed |
| A.1            | 2024/05/20         | Initial version completed     |

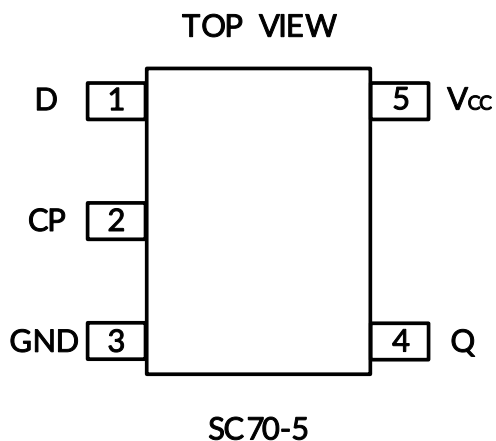
**5 PACKAGE/ORDERING INFORMATION <sup>(1)</sup>**

| <b>PRODUCT</b> | <b>ORDERING NUMBER</b> | <b>TEMPERATURE RANGE</b> | <b>PACKAGE LEAD</b>   | <b>Lead finish/Ball material <sup>(2)</sup></b> | <b>MSL Peak Temp <sup>(3)</sup></b> | <b>PACKAGE MARKING <sup>(4)</sup></b> | <b>PACKAGE OPTION</b> |
|----------------|------------------------|--------------------------|-----------------------|---|-------------------------------------|---------------------------------------|-----------------------|
| RS1G79-Q1      | RS1G79XC5-Q1           | -40°C ~+125°C            | SC70-5 <sup>(5)</sup> | NIPDAUAG  | MSL1-260°-Unlimited                 | 1G79                                  | Tape and Reel,3000    |

**NOTE:**

- (1) This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the right-hand navigation.
- (2) Lead finish/Ball material. Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.
- (3) MSL Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the lot trace code information (data code and vendor code), the logo or the environmental category on the device.
- (5) Equivalent to SOT353.

## 6 PIN CONFIGURATIONS



### 6.1 PIN DESCRIPTION

| PIN    | NAME            | I/O TYPE <sup>(1)</sup> | FUNCTION       |
|--------|-----------------|-------------------------|----------------|
| SC70-5 |                 |                         |                |
| 1      | D               | I                       | Date Input     |
| 2      | CP              | I                       | Clock Input    |
| 3      | GND             | -                       | Ground         |
| 4      | Q               | O                       | Output         |
| 5      | V <sub>cc</sub> | P                       | Supply Voltage |

(1) I=input, O=output, P=power.

### 6.2 FUNCTION TABLE

| INPUTS |   | OUTPUT         |
|--------|---|----------------|
| CP     | D | Q              |
| ↑      | H | H              |
| ↑      | L | L              |
| L      | X | Q <sub>0</sub> |

(1) H=High Voltage Level  
L=Low Voltage Level  
X=Don't Care

## 7 SPECIFICATIONS

### 7.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted) <sup>(1)(2)</sup>

|                  |   | MIN               | MAX                  | UNIT |
|------------------|---|-------------------|----------------------|------|
| V <sub>CC</sub>  | Supply voltage range  | -0.5              | 6.5                  | V    |
| V <sub>I</sub>   | Input voltage range <sup>(2)</sup>  | -0.5              | 6.5                  | V    |
| V <sub>O</sub>   | Voltage range applied to any output in the high-impedance or power-off state <sup>(2)</sup> | -0.5              | 6.5                  | V    |
| V <sub>O</sub>   | Voltage range applied to any output in the high or low state <sup>(2)(3)</sup>              | -0.5              | V <sub>CC</sub> +0.5 | V    |
| I <sub>IK</sub>  | Input clamp current   | V <sub>I</sub> <0 | -50                  | mA   |
| I <sub>OK</sub>  | Output clamp current  | V <sub>O</sub> <0 | -50                  | mA   |
| I <sub>O</sub>   | Continuous output current   |                   | ±50                  | mA   |
|                  | Continuous current through V <sub>CC</sub> or GND   |                   | ±100                 | mA   |
| θ <sub>JA</sub>  | Package thermal impedance <sup>(4)</sup>  | SC70-5            | 380                  | °C/W |
| T <sub>J</sub>   | Junction temperature <sup>(5)</sup>   | -65               | 150                  | °C   |
| T <sub>stg</sub> | Storage temperature   | -65               | 150                  | °C   |

- (1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.
- (3) The value of V<sub>CC</sub> is provided in the Recommended Operating Conditions table.
- (4) The package thermal impedance is calculated in accordance with JESD-51.
- (5) The maximum power dissipation is a function of T<sub>J(MAX)</sub>, R<sub>θJA</sub>, and T<sub>A</sub>. The maximum allowable power dissipation at any ambient temperature is P<sub>D</sub> = (T<sub>J(MAX)</sub> - T<sub>A</sub>) / R<sub>θJA</sub>. All numbers apply for packages soldered directly onto a PCB.

### 7.2 ESD Ratings

The following ESD information is provided for handling of ESD-sensitive devices in an ESD protected area only.

|                    |                         | VALUE   | UNIT  |
|--------------------|-------------------------|---|-------|
| V <sub>(ESD)</sub> | Electrostatic discharge | Human-Body Model (HBM), per AEC Q100-002 <sup>(1)</sup> | ±2000 |
|                    |                         | Charged-Device Model (CDM), per AEC Q100-011            | ±1000 |
|                    |                         | Latch-Up (LU), per AEC Q100-004                         | ±150  |
|                    |                         |   | mA    |

- (1) AEC Q100-002 indicates that HBM stressing shall be in accordance with the ANSI/ESDA/JEDEC JS-001 specification.



#### ESD SENSITIVITY CAUTION

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

## 8 ELECTRICAL CHARACTERISTICS

over recommended operating free-air temperature range (TYP values are at  $T_A = +25^\circ\text{C}$ , Full= $-40^\circ\text{C}$  to  $125^\circ\text{C}$ , unless otherwise noted.) <sup>(1)</sup>

### 8.1 Recommended Operating Conditions

| PARAMETER                     | SYMBOL                | TEST CONDITIONS  | MIN                  | MAX                  | UNIT             |
|-------------------------------|-----------------------|--|----------------------|----------------------|------------------|
| Supply voltage                | $V_{CC}$              | Operating  | 1.65                 | 5.5                  | V                |
| High-level input voltage      | $V_{IH}$              | $V_{CC}=1.65\text{V to }1.95\text{V}$                              | $0.75 \times V_{CC}$ |                      | V                |
|                               |                       | $V_{CC}=2.3\text{V to }2.7\text{V}$                                | 1.7                  |                      |                  |
|                               |                       | $V_{CC}=3\text{V to }3.6\text{V}$                                  | 2.3                  |                      |                  |
|                               |                       | $V_{CC}=4.5\text{V to }5.5\text{V}$                                | $0.7 \times V_{CC}$  |                      |                  |
| Low-level input voltage       | $V_{IL}$              | $V_{CC}=1.65\text{V to }1.95\text{V}$                              |                      | $0.25 \times V_{CC}$ | V                |
|                               |                       | $V_{CC}=2.3\text{V to }2.7\text{V}$                                |                      | 0.7                  |                  |
|                               |                       | $V_{CC}=3\text{V to }3.6\text{V}$                                  |                      | 0.8                  |                  |
|                               |                       | $V_{CC}=4.5\text{V to }5.5\text{V}$                                |                      | $0.3 \times V_{CC}$  |                  |
| Input voltage                 | $V_I$                 |  | 0                    | 5.5                  | V                |
| Output voltage                | $V_O$                 |  | 0                    | $V_{CC}$             | V                |
| High-level output current     | $I_{OH}$              | $V_{CC}=1.65\text{V}$  |                      | -4                   | mA               |
|                               |                       | $V_{CC}=2.3\text{V}$   |                      | -8                   |                  |
|                               |                       | $V_{CC}=3\text{V}$   |                      | -16                  |                  |
|                               |                       | $V_{CC}=4.5\text{V}$   |                      | -24                  |                  |
| Low-level output current      | $I_{OL}$              | $V_{CC}=1.65\text{V}$  |                      | 4                    | mA               |
|                               |                       | $V_{CC}=2.3\text{V}$   |                      | 8                    |                  |
|                               |                       | $V_{CC}=3\text{V}$   |                      | 16                   |                  |
|                               |                       | $V_{CC}=4.5\text{V}$   |                      | 24                   |                  |
| Input transition rise or fall | $\Delta t / \Delta v$ | $V_{CC}=1.8\text{V} \pm 0.15\text{V}, 2.5\text{V} \pm 0.2\text{V}$ |                      | 20                   | ns/V             |
|                               |                       | $V_{CC}=3.3\text{V} \pm 0.3\text{V}$                               |                      | 10                   |                  |
|                               |                       | $V_{CC}=5\text{V} \pm 0.5\text{V}$                                 |                      | 5                    |                  |
| Operating temperature         | $T_A$                 |  | -40                  | 125                  | $^\circ\text{C}$ |

(1) All unused inputs of the device must be held at  $V_{CC}$  or GND to ensure proper device operation.

**8.2 DC Characteristics**

| PARAMETER                          |            | TEST CONDITIONS  | V <sub>CC</sub> | TEMP  | MIN <sup>(2)</sup>   | TYP <sup>(3)</sup> | MAX <sup>(2)</sup> | UNIT |
|------------------------------------|------------|--|-----------------|-------|----------------------|--------------------|--------------------|------|
| V <sub>OH</sub>                    |            | I <sub>OH</sub> = -100μA   | 1.65V to 5.5V   | Full  | V <sub>CC</sub> -0.1 |                    |                    | V    |
|                                    |            | I <sub>OH</sub> = -4mA   | 1.65V           |       | 1.2                  |                    |                    |      |
|                                    |            | I <sub>OH</sub> = -8mA   | 2.3V            |       | 1.9                  |                    |                    |      |
|                                    |            | I <sub>OH</sub> = -16mA  | 3V              |       | 2.4                  |                    |                    |      |
|                                    |            | I <sub>OH</sub> = -24mA  |                 |       | 2.3                  |                    |                    |      |
|                                    |            | I <sub>OH</sub> = -32mA  | 4.5V            |       | 3.8                  |                    |                    |      |
| V <sub>OL</sub>                    |            | I <sub>OL</sub> = 100μA  | 1.65V to 5.5V   | Full  |                      |                    | 0.1                | V    |
|                                    |            | I <sub>OL</sub> = 4mA  | 1.65V           |       |                      |                    | 0.45               |      |
|                                    |            | I <sub>OL</sub> = 8mA  | 2.3V            |       |                      |                    | 0.3                |      |
|                                    |            | I <sub>OL</sub> = 16mA   | 3V              |       |                      |                    | 0.4                |      |
|                                    |            | I <sub>OL</sub> = 24mA   |                 |       |                      |                    | 0.55               |      |
|                                    |            | I <sub>OL</sub> = 32mA   | 4.5V            |       |                      |                    | 0.55               |      |
| I <sub>i</sub>                     | All inputs | V <sub>I</sub> =5.5V or GND  | 0V to 5.5V      | +25°C |                      | ±0.1               | ±1                 | μA   |
|                                    |            |  |                 | Full  |                      |                    | ±5                 |      |
| I <sub>off</sub>                   |            | V <sub>I</sub> or V <sub>O</sub> =5.5V                                     | 0               | +25°C |                      | ±0.1               | ±1                 | μA   |
|                                    |            |  |                 | Full  |                      |                    | ±10                |      |
| I <sub>CC</sub>                    |            | V <sub>I</sub> =5.5V or GND, I <sub>O</sub> =0                             | 1.65V to 5.5V   | +25°C |                      | 0.1                | 1                  | μA   |
|                                    |            |  |                 | Full  |                      |                    | 10                 |      |
| ΔI <sub>CC</sub>                   |            | One input at V <sub>CC</sub> -0.6V, Other inputs at V <sub>CC</sub> or GND | 3V to 5.5V      | Full  |                      |                    | 500                | μA   |
| C <sub>i</sub> (Input Capacitance) |            | V <sub>I</sub> = V <sub>CC</sub> or GND                                    | 3.3V            | +25°C |                      | 4                  |                    | pF   |

(1) All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation.

(2) Limits are 100% production tested at 25°C. Limits over the operating temperature range are ensured through correlations using statistical quality control (SQC) method.

(3) Typical values represent the most likely parametric norm as determined at the time of characterization. Actual typical values may vary over time and will also depend on the application and configuration.



### 8.3 Timing Requirements <sup>(1)</sup>

over recommended operating free-air temperature range ( $T_A = +25^\circ\text{C}$ , unless otherwise noted) <sup>(1)</sup>

| PARAMETER          |                                      | $V_{CC}=1.8V\pm 0.15V$ |     | $V_{CC}=2.5V\pm 0.2V$ |     | $V_{CC}=3.3V\pm 0.3V$ |     | $V_{CC}=5V\pm 0.5V$ |     | UNIT |
|--------------------|--------------------------------------|------------------------|-----|-----------------------|-----|-----------------------|-----|---------------------|-----|------|
|                    |                                      | MIN                    | MAX | MIN                   | MAX | MIN                   | MAX | MIN                 | MAX |      |
| $f_{\text{clock}}$ | Clock frequency                      |                        | 30  |                       | 65  |                       | 100 |                     | 155 | MHz  |
| $t_w$              | Pulse duration, CLK high or low      | 8                      |     | 4                     |     | 3                     |     | 2                   |     | ns   |
| $t_{\text{su}}$    | Setup time before CLK $\uparrow$     | Data high              | 8   | 4                     |     | 3                     |     | 1                   |     |      |
|                    |                                      | Data low               | 8   | 4                     |     | 3                     |     | 1                   |     |      |
| $t_h$              | Hold time, data after CLK $\uparrow$ | 1                      |     | 1                     |     | 1                     |     | 1                   |     |      |

(1) This parameter is ensured by design and/or characterization and is not tested in production.

### 8.4 Switching Characteristics

over recommended operating free-air temperature range ( $T_A = +25^\circ\text{C}$ , unless otherwise noted) <sup>(1)</sup>

| PARAMETER        | FROM (INPUT) | TO (OUTPUT) | TEST CONDITIONS        |  | TEMP | MIN | TYP  | MAX  | UNIT |
|------------------|--------------|-------------|------------------------|--|------|-----|------|------|------|
| $f_{\text{max}}$ |              |             |                        |  |      |     |      | 155  | MHz  |
| $t_{\text{pd}}$  | CP           | Q           | $V_{CC}=1.8V\pm 0.15V$ | $C_L=30\text{pF}, R_L=1\text{k}\Omega$ | FULL | 6   | 25   | 40   | ns   |
|                  |              |             | $V_{CC}=2V\pm 0.15V$   | $C_L=30\text{pF}, R_L=1\text{k}\Omega$ | FULL | 4.8 | 20   | 32.5 |      |
|                  |              |             | $V_{CC}=2.5V\pm 0.2V$  | $C_L=30\text{pF}, R_L=500\Omega$       | FULL | 3   | 11.5 | 19   |      |
|                  |              |             | $V_{CC}=3.3V\pm 0.3V$  | $C_L=50\text{pF}, R_L=500\Omega$       | FULL | 2.6 | 9    | 14.5 |      |
|                  |              |             | $V_{CC}=5V\pm 0.5V$    | $C_L=50\text{pF}, R_L=500\Omega$       | FULL | 1.6 | 7.5  | 12   |      |

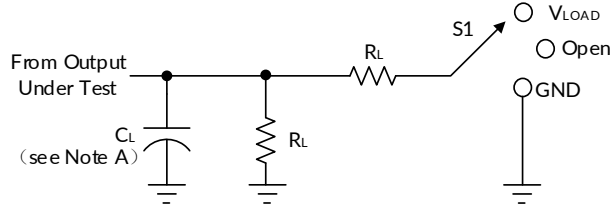
(1) This parameter is ensured by design and/or characterization and is not tested in production.

### 8.5 Operating Characteristics

$T_A = +25^\circ\text{C}$

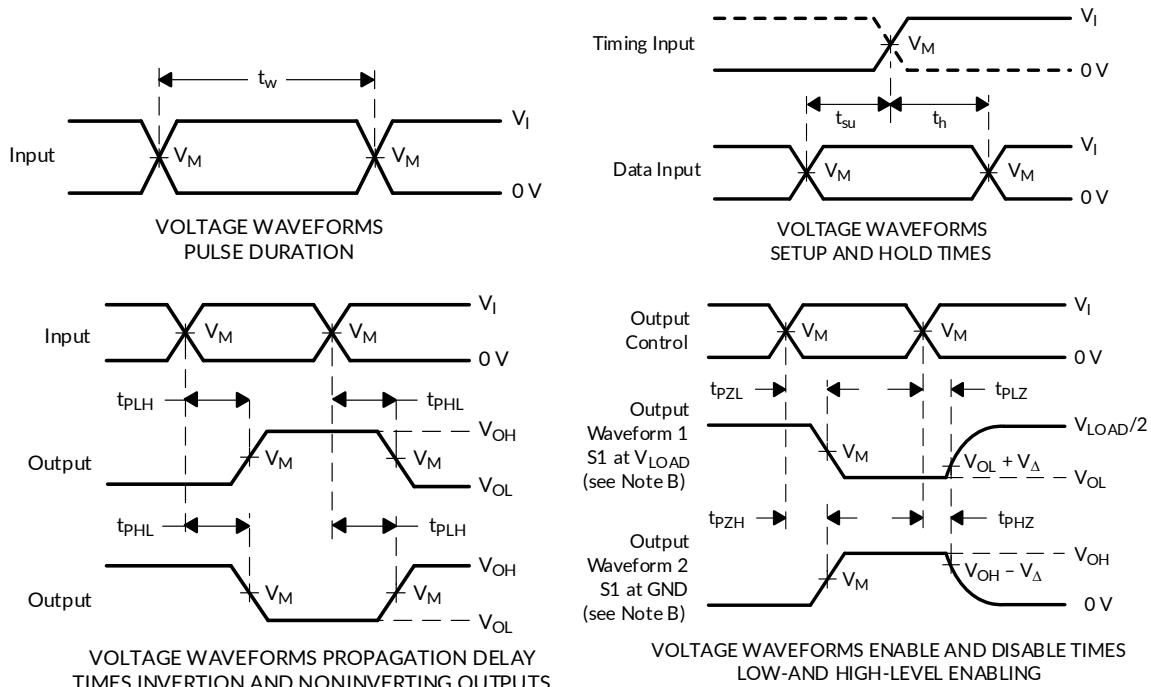
| PARAMETER                                     | TEST CONDITIONS     | $V_{CC} = 1.8V$ | $V_{CC} = 2.5V$ | $V_{CC} = 3.3V$ | $V_{CC} = 5V$ | UNIT |
|---|---------------------|-----------------|-----------------|-----------------|---------------|------|
|   |                     | TYP             | TYP             | TYP             | TYP           |      |
| $C_{\text{pd}}$ Power dissipation capacitance | $f = 10\text{ MHz}$ | 12              | 15              | 19              | 24            | pF   |

## 9 PARAMETER MEASUREMENT INFORMATION



| TEST              | S1         |
|-------------------|------------|
| $t_{PLH}/t_{PHL}$ | Open       |
| $t_{PLZ}/t_{PZL}$ | $V_{LOAD}$ |
| $t_{PHZ}/t_{PZH}$ | GND        |

| $V_{CC}$         | INPUTS   |              | $V_M$      | $V_{LOAD}$        | $C_L$ | $R_L$        | $V_{\Delta}$ |
|------------------|----------|--------------|------------|-------------------|-------|--------------|--------------|
|                  | $V_I$    | $t_r/t_f$    |            |                   |       |              |              |
| $1.8V \pm 0.15V$ | $V_{CC}$ | $\leq 2ns$   | $V_{CC}/2$ | $2 \times V_{CC}$ | 30pF  | 1k $\Omega$  | 0.15V        |
| $2.5V \pm 0.2V$  | $V_{CC}$ | $\leq 2ns$   | $V_{CC}/2$ | $2 \times V_{CC}$ | 30pF  | 500 $\Omega$ | 0.15V        |
| $3.3V \pm 0.3V$  | 3V       | $\leq 2.5ns$ | 1.5V       | 6V                | 50pF  | 500 $\Omega$ | 0.3V         |
| $5V \pm 0.5V$    | $V_{CC}$ | $\leq 2.5ns$ | $V_{CC}/2$ | $2 \times V_{CC}$ | 50pF  | 500 $\Omega$ | 0.3V         |



- NOTES: A.  $C_L$  includes probe and jig capacitance.  
 B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.  
 C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10$  MHz,  $Z_O = 50\Omega$ .  
 D. The outputs are measured one at a time, with one transition per measurement.  
 E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .  
 F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .  
 G.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .  
 H. All parameters and waveforms are not applicable to all devices.

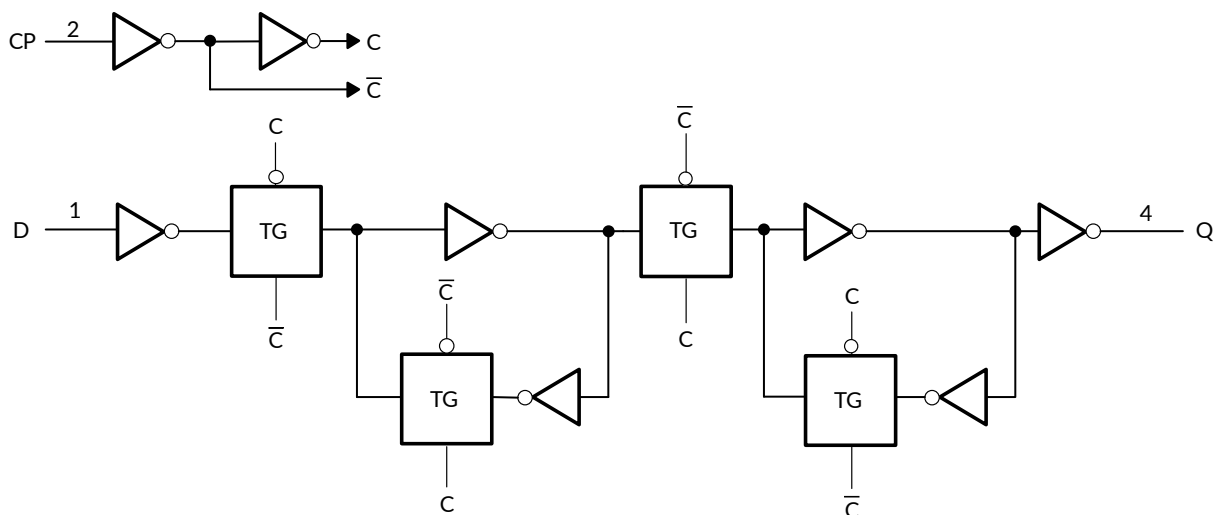
**Figure 1. Load Circuit and Voltage Waveforms**

## 10 DETAILED DESCRIPTION

### 10.1 Overview

The RS1G79-Q1 is a single positive-edge-triggered D-type flip-flop. Data at the input (D) is transferred to the output (Q) on the positive-going edge of the clock pulse when the setup time requirement is met. Because the clock triggering occurs at a voltage level, it is not directly related to the rise time of the clock pulse. This allows for data at the input to be changed without affecting the level at the output, following the hold-time interval.

### 10.2 Functional Block Diagram



**Figure 2. Logic Diagram (Positive Logic)**

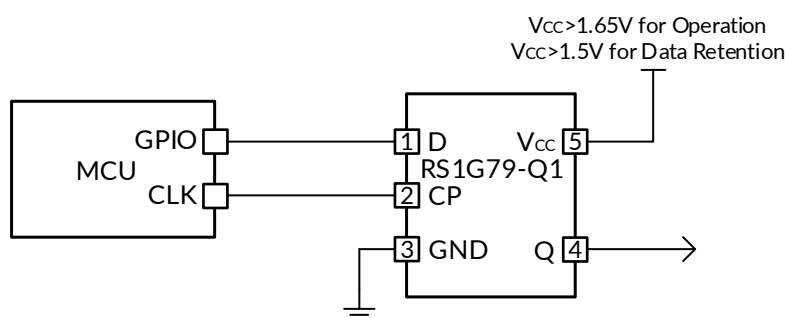
## 11 APPLICATION AND IMPLEMENTATION

Information in the following applications sections is not part of the Runic component specification, and Runic does not warrant its accuracy or completeness. Runic's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### 11.1 Application Information

A useful application for the RS1G79-Q1 is using it as a data latch with low-voltage data retention. This application implements the use of a microcontroller GPIO pin to act as a clock to set the output state and a second GPIO to provide the input data. If the RS1G79-Q1 is being powered from 1.8 V and there is concern that a power glitch could exist as low as 1.5 V, the device will retain the state of the Q output. The  $V_{CC}$  drops to 1.5 V, and when the  $V_{CC}$  returns to 1.8 V, the Q output remains in a high output state. If the  $V_{CC}$  voltage drops below 1.5 V, data retention is not guaranteed.

### 11.2 Typical Application



**Figure 3. Low Voltage Data Retention with RS1G79-Q1**

#### 11.2.1 Design Requirements

The RS1G79-Q1 device uses CMOS technology and has balanced output drive. Take care to avoid bus contention because it can drive currents that would exceed maximum limits.

#### 11.2.2 Detailed Design Procedure

1. Recommended input conditions:
  - For rise time and fall time specifications, see  $\Delta t/\Delta v$  in Recommended Operating Conditions.
  - For specified high and low levels, see  $V_{IH}$  and  $V_{IL}$  in Recommended Operating Conditions.
  - Input voltages are recommended to not go below 0V and not exceed 5.5 V for any  $V_{CC}$ . See Recommended Operating Conditions.
2. Recommended output conditions:
  - Load currents should not exceed  $\pm 50$  mA. See Absolute Maximum Ratings.
  - Output voltages are recommended to not go below 0V and not exceed the  $V_{CC}$  voltage. See Recommended Operating Conditions.

## 12 POWER SUPPLY RECOMMENDATIONS

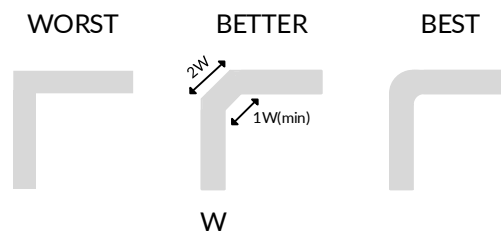
The power supply can be any voltage between the minimum and maximum supply voltage rating listed in Recommended Operating Conditions. A  $0.1\mu\text{F}$  bypass capacitor is recommended to be connected from the  $V_{CC}$  terminal to GND to prevent power disturbance. To reject different frequencies of noise, use multiple bypass capacitors in parallel. Capacitors with values of  $0.1\mu\text{F}$  and  $1\mu\text{F}$  are commonly used in parallel. The bypass capacitor must be installed as close to the power terminal as possible for best results.

## 13 LAYOUT

### 13.1 Layout Guidelines

When a PCB trace turns a corner at a 90° angle, a reflection can occur. A reflection occurs primarily because of the change of width of the trace. At the apex of the turn, the trace width increases to 1.414 times the width. This increase upsets the transmission-line characteristics, especially the distributed capacitance and self-inductance of the trace which results in the reflection. Not all PCB traces can be straight and therefore some traces must turn corners. Figure 4 shows progressively better techniques of rounding corners. Only the last example (BEST) maintains constant trace width and minimizes reflections.

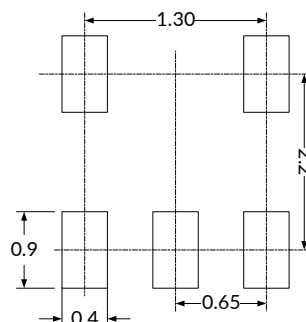
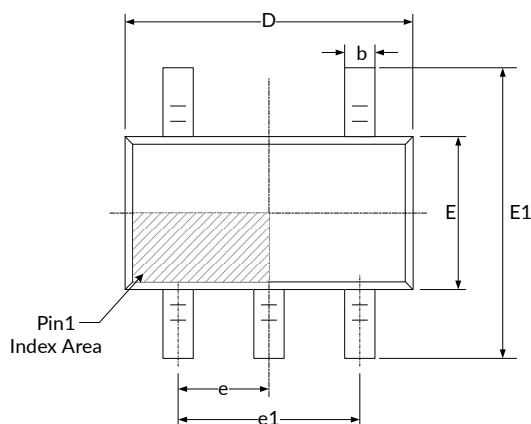
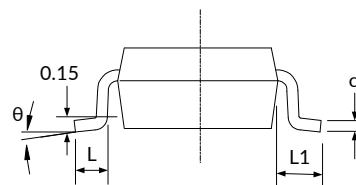
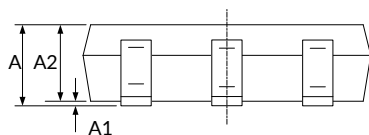
### 13.2 Layout Example



**Figure 4. Trace Example**

# 14 PACKAGE OUTLINE DIMENSIONS

## SC70-5 (4)


**RECOMMENDED LAND PATTERN (Unit: mm)**


| Symbol           | Dimensions In Millimeters |       | Dimensions In Inches      |       |
|------------------|---------------------------|-------|---------------------------|-------|
|                  | Min                       | Max   | Min                       | Max   |
| A <sup>(1)</sup> | 0.850                     | 1.050 | 0.033                     | 0.041 |
| A1               | 0.000                     | 0.100 | 0.000                     | 0.004 |
| A2               | 0.800                     | 1.000 | 0.031                     | 0.039 |
| b                | 0.150                     | 0.350 | 0.006                     | 0.014 |
| c                | 0.080                     | 0.150 | 0.003                     | 0.006 |
| D <sup>(1)</sup> | 2.020                     | 2.120 | 0.079                     | 0.084 |
| E <sup>(1)</sup> | 1.250                     | 1.350 | 0.049                     | 0.053 |
| E1               | 2.200                     | 2.400 | 0.087                     | 0.094 |
| e                | 0.650(BSC) <sup>(2)</sup> |       | 0.026(BSC) <sup>(2)</sup> |       |
| e1               | 1.300(BSC) <sup>(2)</sup> |       | 0.051(BSC) <sup>(2)</sup> |       |
| L                | 0.280                     | 0.380 | 0.011                     | 0.015 |
| L1               | 0.500(REF) <sup>(3)</sup> |       | 0.020(REF) <sup>(3)</sup> |       |
| θ                | 0°                        | 8°    | 0°                        | 8°    |

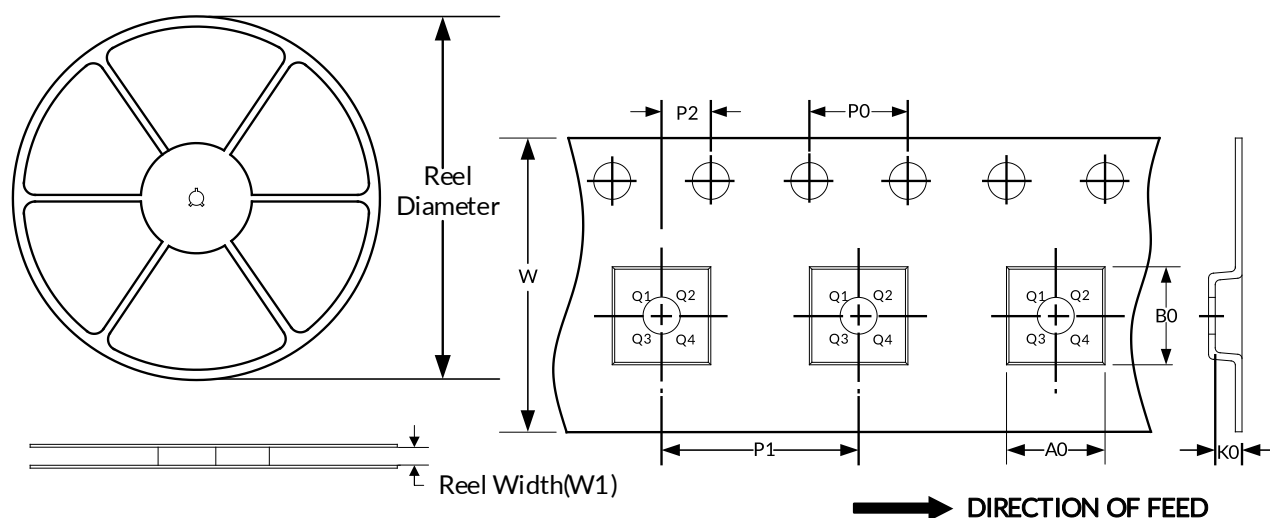
**NOTE:**

1. Plastic or metal protrusions of 0.15mm maximum per side are not included.
2. BSC (Basic Spacing between Centers), "Basic" spacing is nominal.
3. REF is the abbreviation for Reference.
4. This drawing is subject to change without notice.

## 15 TAPE AND REEL INFORMATION

### REEL DIMENSIONS

### TAPE DIMENSION



NOTE: The picture is only for reference. Please make the object as the standard.

### KEY PARAMETER LIST OF TAPE AND REEL

| Package Type | Reel Diameter | Reel Width(mm) | A0 (mm) | B0 (mm) | K0 (mm) | P0 (mm) | P1 (mm) | P2 (mm) | W (mm) | Pin1 Quadrant |
|--------------|---------------|----------------|---------|---------|---------|---------|---------|---------|--------|---------------|
| SC70-5       | 7"            | 9.5            | 2.25    | 2.55    | 1.20    | 4.0     | 4.0     | 2.0     | 8.0    | Q3            |

NOTE:

1. All dimensions are nominal.
2. Plastic or metal protrusions of 0.15mm maximum per side are not included.

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